

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT7266133

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	RELEASE OF SECURITY INTEREST RECORDED AT REEL/FRAME 032113/0158
<b>SEQUENCE:</b>	3
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
THE DIRECTOR OF DEVELOPMENT OF THE STATE OF OHIO FKA THE DIRECTOR OF THE OHIO DEVELOPMENT SERVICES AGENCY	03/25/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	BLUE SPARK TECHNOLOGIES, INC.
<b>Street Address:</b>	806 SHARON DRIVE, SUITE G
<b>City:</b>	WESTLAKE
<b>State/Country:</b>	OHIO
<b>Postal Code:</b>	44145
<b>PROPERTY NUMBERS Total: 4</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	9027242
<b>Patent Number:</b>	8765284
<b>Patent Number:</b>	9782082
<b>Application Number:</b>	61730083
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(650)739-3900
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6507393939
<b>Email:</b>	DebbieWu@JonesDay.com
<b>Correspondent Name:</b>	JONES DAY
<b>Address Line 1:</b>	250 VESEY STREET
<b>Address Line 4:</b>	NEW YORK, NEW YORK 10281-1047
<b>ATTORNEY DOCKET NUMBER:</b>	352049-000002
<b>NAME OF SUBMITTER:</b>	DEBBIE WU
<b>SIGNATURE:</b>	/Debbie Wu/
<b>DATE SIGNED:</b>	04/06/2022
<b>Total Attachments: 4</b>	

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## **Release of Security Interest in Patents**

This Release of Security Interest in Patents (this "*Release*") is made as March 30, 2022, by THE DIRECTOR OF DEVELOPMENT OF THE STATE OF OHIO fka THE DIRECTOR OF THE OHIO DEVELOPMENT SERVICES AGENCY (the "*Director*"), in favor of BLUE SPARK TECHNOLOGIES, INC., an Ohio corporation (the "*Corporation*").

WHEREAS, pursuant to the terms and conditions of that certain Security Agreement dated October 16, 2013 (the "*Security Agreement*"), between the Corporation and the Director, the Corporation granted to the Director a security interest in and to the Corporation's right, title and interest in, to and under the Collateral (as defined in the Security Agreement), including without limitation all of the Corporation's Patents (as defined in the Security Agreement), including without limitation those set forth on Exhibit A attached hereto (collectively, the "*Patents*");

WHEREAS, the Security Agreement was recorded with the United States Patent and Trademark Office on October 21, 2013 at Reel 32113, Frame 0158 against the Patents set forth on Exhibit B attached hereto, which are a subset of the Patents; and

WHEREAS, the Corporation and the Director have agreed that the security interest in and to the Collateral, including without limitation in and to the Patents, shall be terminated, that all right, title, and interest of Director and its successors and assigns in, to, and under the Collateral, including without limitation in, to and under the Patents, shall be transferred to the Company, and that the Security Agreement shall be terminated.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the Director, on behalf of itself and its successors and assigns, hereby irrevocably: (a) terminates, cancels, discharges, and releases any and all security interests the Director and each of its successors and assigns has in, to, under, on, and against the Patents and the goodwill symbolized thereby, (b) grants, bargains, sells, conveys, assigns, and transfers to the Corporation all right, title, and interest of the Director and each of its successors and assigns in, to, and under the Patents and the goodwill symbolized thereby, and (c) terminates, and authorizes and acknowledges the termination of, the Security Agreement and releases and discharges the Corporation and its successors and assigns from any and all obligations thereunder.

The Corporation shall be, and hereby is, authorized to file such release, satisfaction and discharge documents necessary to effect a complete release of the Director's and its successors' and assigns' security interests in the Patents, and the Director, on behalf of itself and its successors and assigns, shall, where applicable, deliver, execute and/or endorse, such releases, satisfactions and discharges evidencing or effecting such release as may be reasonably requested and prepared from time to time by the Corporation and as are reasonably acceptable to the Director as to form and substance.

This Release shall be governed by, and construed and interpreted in accordance with, the laws of the State of Ohio.

IN WITNESS WHEREOF, the Director has caused this Release to be executed by its duly authorized representatives as of the date set forth above.

THE DIRECTOR OF DEVELOPMENT  
OF THE STATE OF OHIO fka Ohio  
Development Services Agency

By *Matthew McClellan*  
Name: \_\_\_\_\_  
Title: Matthew McClellan  
Assistant Director

STATE OF OHIO        )  
                                  ) SS.  
COUNTY OF FRANKLIN )

On this 26<sup>th</sup> day of March, 2022, there appeared before me  
Matthew McClellan, personally known to me, who acknowledged that he signed  
the foregoing Release of Security Interest in Patents as his voluntary act and deed on behalf and  
with full authority of The Director of Development, State of Ohio as its Assistant Director.



Benjamin T. LaGrasso, Attorney At Law  
NOTARY PUBLIC - STATE OF OHIO  
My commission has no expiration date  
Sec. 147.03 R.C.

*[Signature]*  
Notary Public

## Exhibit A

Title	Country	Application No.	Filing Date	Status
Thin Printable Flexible Electrochemical Cell and Method of Making Same	Europe	05738398.0	April 21, 2005	Pending
Thin Printable Flexible Electrochemical Cell and Method of Making Same	Hong Kong	07108448.4	April 21, 2005	Pending
Thin Printable Flexible Electrochemical Cell and Method of Making Same	Japan	2007-509672	April 21, 2005	Issued as Pat. No. 4896456 on May 18, 2012
Thin Printable Flexible Electrochemical Cell and Method of Making Same	South Korea	10-2006-7021980	April 21, 2005	Issued as Pat. No. 10-1220575 on January 3, 2013
Thin Printable Electrochemical Cell and Methods of Making the Same	South Korea	10-2012-7013117	May 21, 2012	Allowed
Thin Printable Flexible Electrochemical Cell and Method of Making Same	US	11/110,203	April 20, 2005	Pending
Thin Printable Electrochemical Cell Utilizing a "Picture Frame" and Methods of Making the Same	Europe	06789076.9	March 21, 2006	Pending
Thin Printable Electrochemical Cell Utilizing a "Picture Frame" and Methods of Making the Same	Japan	2008-503084	March 21, 2006	Issued as Pat. No. 5255432 on April 26, 2013
Thin Printable Electrochemical Cell Utilizing a "Picture Frame" and Methods of Making the Same	South Korea	10-2007-7024296	March 21, 2006	Issued as Pat. No. 10-1238939 on 2/29/2013
Thin Printable Electrochemical Cell and Methods of Making the Same	South Korea	10-2012-7024947	September 24, 2012	Issued as Pat. No. 10-1238054 on 2/25/2013
Thin Printable Electrochemical Cell Utilizing a "Picture Frame" and Methods of Making the Same	US	11/376,520	March 17, 2006	Issued as U.S. Pat. No. 8,029,927 on October 4, 2011
Thin Printable Electrochemical Cell and Methods of Making the Same	US	13/223,845	September 1, 2011	Issued as U.S. Pat. No. 8,268,478 on 9/18/2012
RFID Antenna-Battery Assembly and the Method to Make the Same	US	11/379,816	April 24, 2006	Pending
Electrical Device-Battery Assembly and the Method to	US	13/455,308	April 25, 2012	Pending

Title	Country	Application No.	Filing Date	Status
Make the Same				
Integrated Electronic Device and Methods of Making the Same	Europe	06782076.1	July 18, 2006	Pending
Integrated Electronic Device and Methods of Making the Same	US	12/669,067	January 14, 2010	Issued as U.S. Pat. No. 8,441,411 on 5/14/2013
High Current Thin Electrochemical Cell and Methods of Making the Same	Germany	08868145.7	December 18, 2008	Issued as Patent No. 2235773 on 5/8/2013
High Current Thin Electrochemical Cell and Methods of Making the Same	Finland	08868145.7	December 18, 2008	Issued as Patent No. 2235773 on 5/8/2013
High Current Thin Electrochemical Cell and Methods of Making the Same	United Kingdom	08868145.7	December 18, 2008	Issued as Patent No. 2235773 on 5/8/2013
High Current Thin Electrochemical Cell and Methods of Making the Same	Japan	2010-539800	December 18, 2008	Pending
High Current Thin Electrochemical Cell and Methods of Making the Same	South Korea	10-2010-7015828	December 18, 2008	Pending
High Current Thin Electrochemical Cell and Methods of Making the Same	US	12/809,844	June 21, 2010	Allowed
Irreversible Circuit Activation Switch	US	13/075,620	March 30, 2011	Pending
Cell Attachment Method	US	13/625,366	September 24, 2012	Pending
Cell Attachment Method	WO	PCT/US12/56889	September 24, 2012	Pending
Multi-Cell Battery	US	13/899,291	May 21, 2013	Pending
Multi-Cell Battery	WO	PCT/US13/42076	May 21, 2013	Pending
Body Temperature Logging Patch	US	13/623,508	June 25, 2013	Pending
Body Temperature Logging Patch	WO	PCT/US13/47616	June 25, 2013	Pending
Battery Cell Construction	US	81/730,083	November 27, 2012	Pending

**EXHIBIT B**

Application Number: 13/625,366

Patent Number: 9,027,242

Title: Cell Attachment Method

Filing Date: 09/24/2012

Issue Date: 05/12/2015

Application Number: 13/899,291

Patent Number: 8,765,284

Title: Multi-Cell Battery

Filing Date: 05/21/2013

Issue Date: 07/01/2014

Application Number: 13/926,508

Patent Number: 9,782,082

Title: Body Temperature Logging Patch

Filing Date: 06/25/2013

Issue Date: 10/10/2017

Application Number: 61/730,083

Patent Number:

Title: Battery Cell Construction

Filing Date: 11/27/2012

Issue Date: